

# SN5476, SN54LS76A SN7476, SN74LS76A

## DUAL J-K FLIP-FLOPS WITH PRESET AND CLEAR

SDLS121 – DECEMBER 1983 – REVISED MARCH 1988

- Package Options Include Plastic and Ceramic DIPs and Ceramic Flat Packages
- Dependable Texas Instruments Quality and Reliability

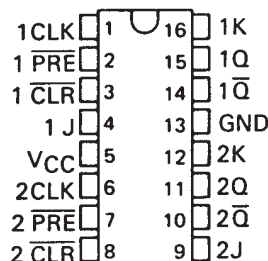
### description

The '76 contains two independent J-K flip-flops with individual J-K, clock, preset, and clear inputs. The '76 is a positive-edge-triggered flip-flop. J-K input is loaded into the master while the clock is high and transferred to the slave on the high-to-low transition. For these devices the J and K inputs must be stable while the clock is high.

The 'LS76A contain two independent negative-edge-triggered flip-flops. The J and K inputs must be stable one setup time prior to the high-to-low clock transition for predicatble operation. The preset and clear are asynchronous active low inputs. When low they override the clock and data inputs forcing the outputs to the steady state levels as shown in the function table.

The SN5476 and the SN54LS76A are characterized for operation over the full military temperature range of  $-55^{\circ}\text{C}$  to  $125^{\circ}\text{C}$ . The SN7476 and the SN74LS76A are characterized for operation from  $0^{\circ}\text{C}$  to  $70^{\circ}\text{C}$ .

SN5476, SN54LS76A . . . J PACKAGE  
SN7476 . . . N PACKAGE  
SN74LS76A . . . D OR N PACKAGE  
(TOP VIEW)



'76  
FUNCTION TABLE

INPUTS					OUTPUTS	
PRE	CLR	CLK	J	K	Q	Q̄
L	H	X	X	X	H	L
H	L	X	X	X	L	H
L	L	X	X	X	H <sup>†</sup>	H <sup>†</sup>
H	H	↓	L	L	Q <sub>0</sub>	Q̄ <sub>0</sub>
H	H	↓	H	L	H	L
H	H	↓	L	H	L	H
H	H	↓	H	H	TOGGLE	

'LS76A  
FUNCTION TABLE

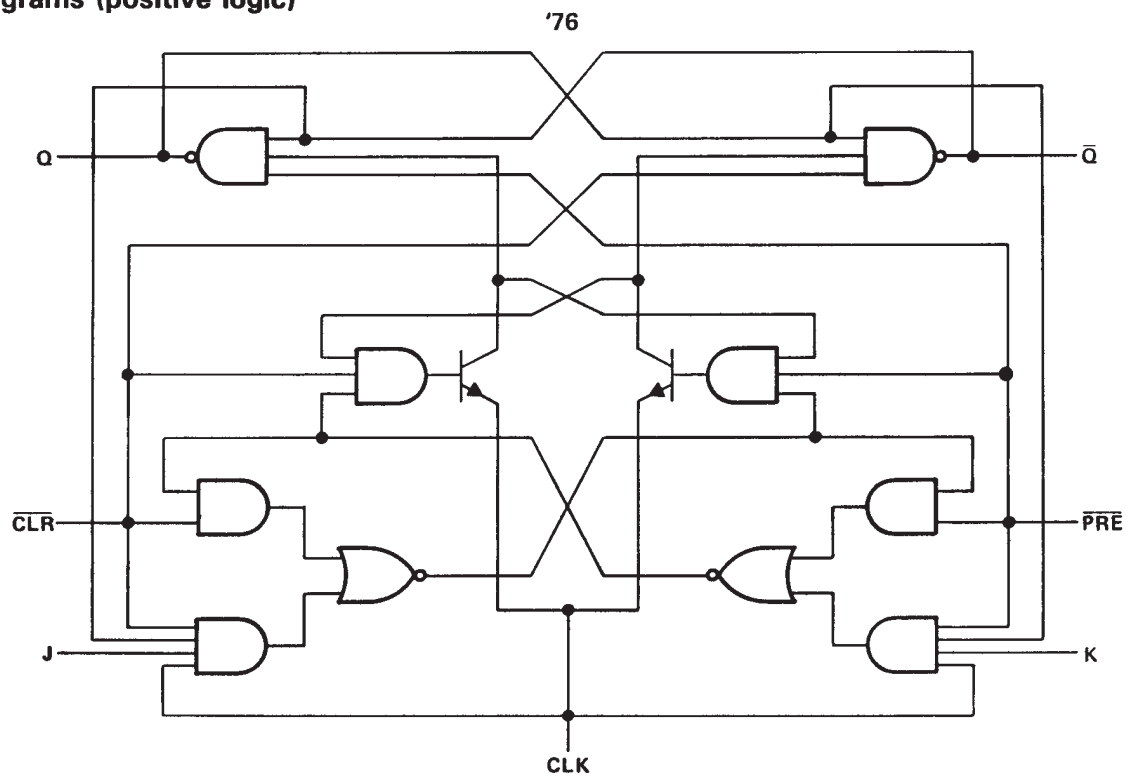
INPUTS					OUTPUTS	
PRE	CLR	CLK	J	K	Q	Q̄
L	H	X	X	X	H	L
H	L	X	X	X	L	H
L	L	X	X	X	H <sup>†</sup>	H <sup>†</sup>
H	H	↓	L	L	Q <sub>0</sub>	Q̄ <sub>0</sub>
H	H	↓	H	L	H	L
H	H	↓	L	H	L	H
H	H	↓	H	H	TOGGLE	
H	H	H	X	X	Q <sub>0</sub>	Q̄ <sub>0</sub>

<sup>†</sup> This configuration is nonstable; that is, it will not persist when either preset or clear returns to its inactive (high) level.

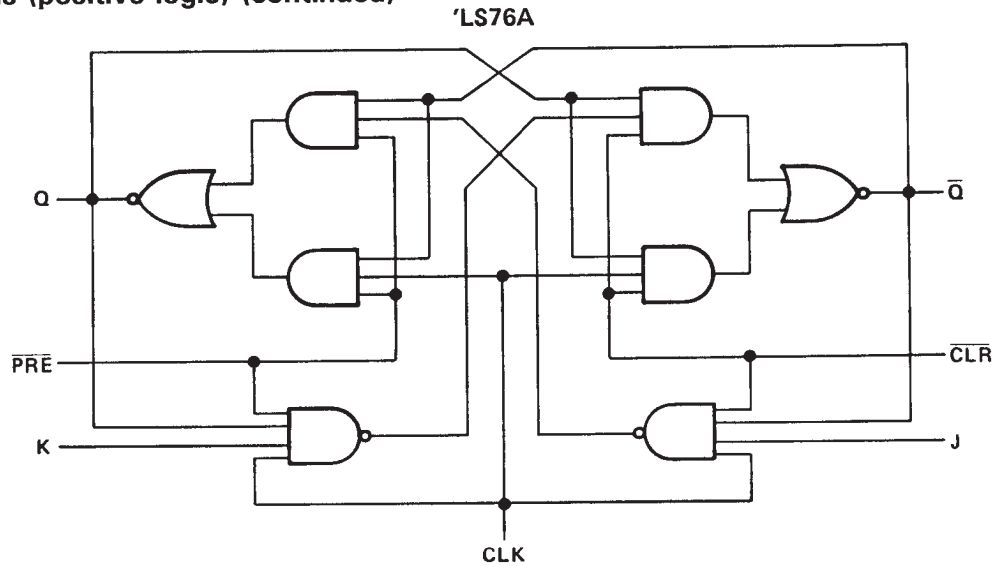
SN5476, SN54LS76A  
SN7476, SN74LS76A  
DUAL J-K FLIP-FLOPS WITH PRESET AND CLEAR

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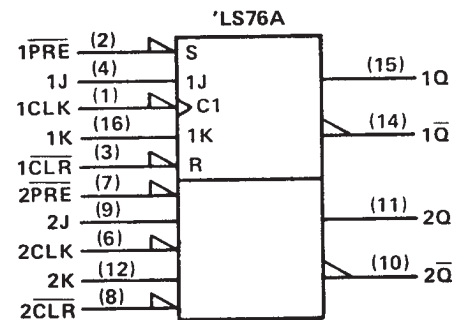
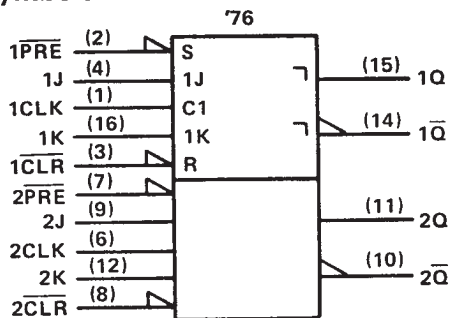
logic diagrams (positive logic)



logic diagrams (positive logic) (continued)

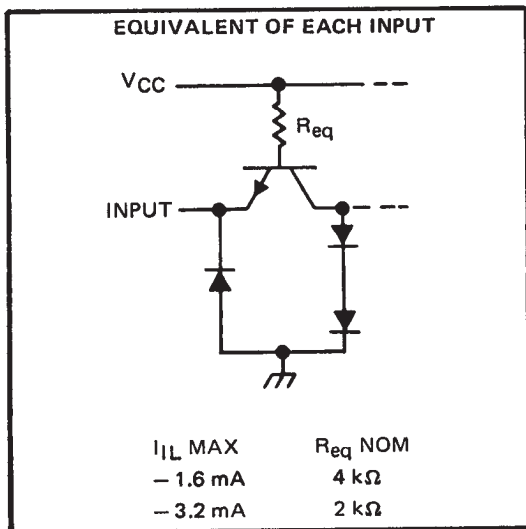


logic symbols†

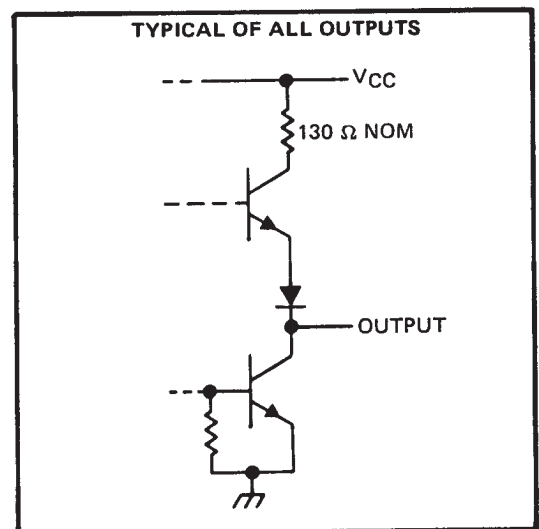


†These symbols are in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

schematics of inputs and outputs

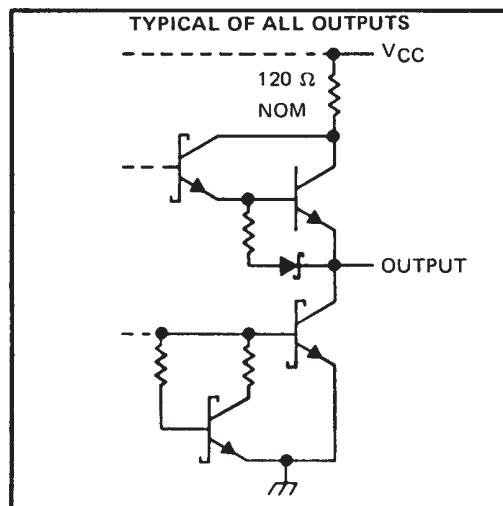


'76



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**'LS76A**



Supply voltage, V <sub>CC</sub> (see Note 1) .....	7 V
Input voltage: '76 .....	5.5 V
'LS76A .....	7 V
Operating free-air temperature range: SN54' .....	–55°C to 125°C
SN74' .....	0°C to 70°C
Storage temperature range .....	–65°C to 150°C



4

SN5476, SN54LS76A  
SN7476, SN74LS76A  
**DUAL J-K FLIP-FLOPS WITH PRESET AND CLEAR**  
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**recommended operating conditions**

			SN5476			SN7476			UNIT
			MIN	NOM	MAX	MIN	NOM	MAX	
V <sub>CC</sub>	Supply voltage		4.5	5	5.5	4.75	5	5.25	V
V <sub>IH</sub>	High-level input voltage		2			2			V
V <sub>IL</sub>	Low-level input voltage		0.8			0.8			V
I <sub>OH</sub>	High-level output current		− 0.4			− 0.4			mA
I <sub>OL</sub>	Low-level output current		16			16			mA
t <sub>w</sub>	Pulse duration		CLK high			20			ns
			CLK low			47			
			PRE or CLR low			25			
t <sub>su</sub>	Input setup time before CLK ↑		0			0			ns
t <sub>h</sub>	Input hold time-data after CLK ↓		0			0			ns
T <sub>A</sub>	Operating free-air temperature		− 55                      125			0                      70			°C

**electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)**

PARAMETER		TEST CONDITIONS†		SN5476			SN7476			UNIT
				MIN	TYP‡	MAX	MIN	TYP‡	MAX	
V <sub>IK</sub>		V <sub>CC</sub> = MIN, I <sub>I</sub> = – 12 mA				– 1.5			– 1.5	V
V <sub>OH</sub>		V <sub>CC</sub> = MIN, V <sub>IH</sub> = 2 V, V <sub>IL</sub> = 0.8 V, I <sub>OH</sub> = – 0.4 mA		2.4	3.4		2.4	3.4		V
V <sub>OL</sub>		V <sub>CC</sub> = MIN, V <sub>IH</sub> = 2 V, V <sub>IL</sub> = 0.8 V, I <sub>OL</sub> = 16 mA			0.2	0.4		0.2	0.4	V
I <sub>I</sub>		V <sub>CC</sub> = MAX, V <sub>I</sub> = 5.5 V				1			1	mA
I <sub>IH</sub>	J or K	V <sub>CC</sub> = MAX, V <sub>I</sub> = 2.4 V				40			40	μA
	All other					80			80	
I <sub>IL</sub>	J or K	V <sub>CC</sub> = MAX, V <sub>I</sub> = 0.4 V				– 1.6			– 1.6	mA
	All other					– 3.2			– 3.2	
I <sub>OS</sub> §		V <sub>CC</sub> = MAX		– 20		– 57	– 18		– 57	mA
I <sub>CC</sub> #		V <sub>CC</sub> = MAX, See Note 2			10	20		10	20	mA

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

‡ All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C.

§ Not more than one output should be shorted at a time.

¶ Clear is tested with preset high and preset is tested with clear high.

# Average per flip-flop.

NOTE 2: With all outputs open, I<sub>CC</sub> is measured with the Q and  $\bar{Q}$  outputs high in turn. At the time of measurement, the clock input is grounded.

**switching characteristics, V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C (see note 3)**

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT
f <sub>max</sub>			R <sub>L</sub> = 400 Ω,                    C <sub>L</sub> = 15 pF	15	20		MHz
t <sub>PLH</sub>	$\overline{\text{PRE}}$ or $\overline{\text{CLR}}$	Q or $\overline{\text{Q}}$			16	25	ns
t <sub>PHL</sub>					25	40	ns
t <sub>PLH</sub>				CLK	Q or $\overline{\text{Q}}$		16
t <sub>PHL</sub>		25				40	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

# SN5476, SN54LS76A SN7476, SN74LS76A DUAL J-K FLIP-FLOPS WITH PRESET AND CLEAR

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## recommended operating conditions

			SN54LS76A			SN74LS76A			UNIT
			MIN	NOM	MAX	MIN	NOM	MAX	
V <sub>CC</sub>	Supply voltage		4.5	5	5.5	4.75	5	5.75	V
V <sub>IH</sub>	High-level input voltage		2			2			V
V <sub>IL</sub>	Low-level input voltage		0.7			0.8			V
I <sub>OH</sub>	High-level output current		− 0.4			− 0.4			mA
I <sub>OL</sub>	Low-level output current		4			8			mA
f <sub>clock</sub>	Clock frequency		0	30		0	30		MHz
t <sub>w</sub>	Pulse duration	CLK high	20			20			ns
		$\overline{\text{PRE}}$ or $\overline{\text{CLR}}$ low	25			25			
t <sub>su</sub>	Setup time before CLK↓	data high or low	20			20			ns
		$\overline{\text{CLR}}$ inactive	20			20			
		$\overline{\text{PRE}}$ inactive	25			25			
t <sub>h</sub>	Hold time-data after CLK↓		0			0			ns
T <sub>A</sub>	Operating free-air temperature		− 55			125			°C
			− 55			125			°C

## electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS†		SN54LS76A			SN74LS76A			UNIT
				MIN	TYP‡	MAX	MIN	TYP‡	MAX	
V <sub>IK</sub>		V <sub>CC</sub> = MIN, I <sub>I</sub> = – 18 mA				– 1.5			– 1.5	V
V <sub>OH</sub>		V <sub>CC</sub> = MIN, V <sub>IH</sub> = 2 V, V <sub>IL</sub> = MAX, I <sub>OH</sub> = – 0.4 mA		2.5	3.4		2.7	3.4		V
V <sub>OL</sub>		V <sub>CC</sub> = MIN, V <sub>IL</sub> = MAX, V <sub>IH</sub> = 2 V, I <sub>OL</sub> = 4 mA			0.25	0.4		0.25	0.4	V
		V <sub>CC</sub> = MIN, V <sub>IL</sub> = MAX, V <sub>IH</sub> = 2 V, I <sub>OL</sub> = 8 mA						0.35	0.5	
I <sub>I</sub>	J or K	V <sub>CC</sub> = MAX, V <sub>I</sub> = 7 V				0.1			0.1	mA
	CLR or PRE					0.3			0.3	
	CLK					0.4			0.4	
I <sub>IH</sub>	J or K	V <sub>CC</sub> = MAX, V <sub>I</sub> = 2.7 V				20			20	µA
	CLR or PRE					60			60	
	CLK					80			80	
I <sub>IL</sub>	J or K	V <sub>CC</sub> = MAX, V <sub>I</sub> = 0.4 V				– 0.4			– 0.4	mA
	All other					– 0.8			– 0.8	
I <sub>OS</sub> §		V <sub>CC</sub> = MAX, See Note 4		– 20		– 100	– 20		– 100	mA
I <sub>CC</sub> (Total)		V <sub>CC</sub> = MAX, See Note 2			4	6		4	6	mA

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

‡ All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C.

§ Not more than one output should be shorted at a time, and the duration of the short circuit should not exceed one second.

NOTE 2: With all outputs open, I<sub>CC</sub> is measured with the Q and Q̄ outputs high in turn. At the time of measurement, the clock input is grounded.

NOTE 4: For certain devices where state commutation can be caused by shorting an output to ground, an equivalent test may be performed with V<sub>O</sub> = 2.25 V and 2.125 V for the 54 family and the 74 family, respectively, with the minimum and maximum limits reduced to one half of their stated values.

## switching characteristics, V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C (see note 3)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT
f <sub>max</sub>				30	45		MHz
t <sub>PLH</sub>	PRE, CLR or CLK	Q or Q̄	R <sub>L</sub> = 2 kΩ, C <sub>L</sub> = 15 pF		15	20	ns
t <sub>PHL</sub>					15	20	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



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**PACKAGING INFORMATION**

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
5962-9557501QEA	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
5962-9557501QFA	ACTIVE	CFP	W	16	1	TBD	Call TI	Level-NC-NC-NC
5962-9557501QFA	ACTIVE	CFP	W	16	1	TBD	Call TI	Level-NC-NC-NC
7601301EA	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
7601301EA	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
JM38510/00204BEA	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
JM38510/00204BEA	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
SN5476J	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
SN5476J	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
SN54LS76AJ	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
SN54LS76AJ	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
SN7476N	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN7476N	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN7476N3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN7476N3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74LS76AD	OBSOLETE	SOIC	D	16		TBD	Call TI	Call TI
SN74LS76AD	OBSOLETE	SOIC	D	16		TBD	Call TI	Call TI
SN74LS76ADR	OBSOLETE	SOIC	D	16		TBD	Call TI	Call TI
SN74LS76ADR	OBSOLETE	SOIC	D	16		TBD	Call TI	Call TI
SN74LS76AN	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74LS76AN	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74LS76AN3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74LS76AN3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SNJ5476J	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
SNJ5476J	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
SNJ5476W	ACTIVE	CFP	W	16	1	TBD	Call TI	Level-NC-NC-NC
SNJ5476W	ACTIVE	CFP	W	16	1	TBD	Call TI	Level-NC-NC-NC
SNJ54LS76AJ	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
SNJ54LS76AJ	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
SNJ54LS76AW	ACTIVE	CFP	W	16	1	TBD	Call TI	Level-NC-NC-NC
SNJ54LS76AW	ACTIVE	CFP	W	16	1	TBD	Call TI	Level-NC-NC-NC

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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J (R-GDIP-T\*\*)

14 LEADS SHOWN

# CERAMIC DUAL IN-LINE PACKAGE



PINS ** DIM	14	16	18	20
A	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC
B MAX	0.785 (19,94)	.840 (21,34)	0.960 (24,38)	1.060 (26,92)
B MIN	—	—	—	—
C MAX	0.300 (7,62)	0.300 (7,62)	0.310 (7,87)	0.300 (7,62)
C MIN	0.245 (6,22)	0.245 (6,22)	0.220 (5,59)	0.245 (6,22)

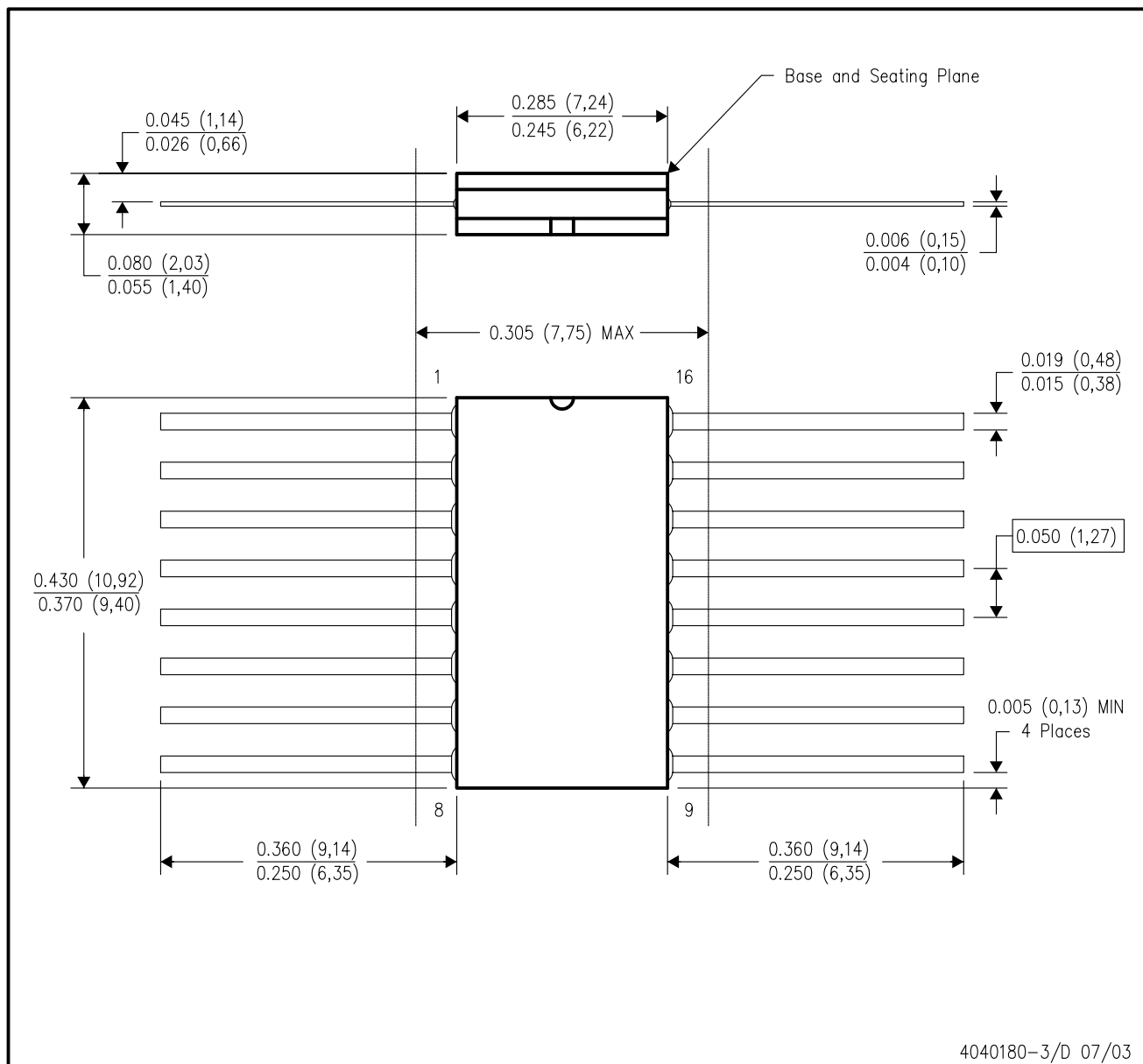


4040083/F 03/03

- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. This package is hermetically sealed with a ceramic lid using glass frit.
  - D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
  - E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

W (R-GDFP-F16)

CERAMIC DUAL FLATPACK



- NOTES:
- All linear dimensions are in inches (millimeters).
  - This drawing is subject to change without notice.
  - This package can be hermetically sealed with a ceramic lid using glass frit.
  - Index point is provided on cap for terminal identification only.
  - Falls within MIL STD 1835 GDFP1-F16 and JEDEC MO-092AC

## N (R-PDIP-T\*\*)

16 PINS SHOWN

## PLASTIC DUAL-IN-LINE PACKAGE



PINS **	14	16	18	20
DIM				
A MAX	0.775 (19,69)	0.775 (19,69)	0.920 (23,37)	1.060 (26,92)
A MIN	0.745 (18,92)	0.745 (18,92)	0.850 (21,59)	0.940 (23,88)
MS-001 VARIATION	AA	BB	AC	AD

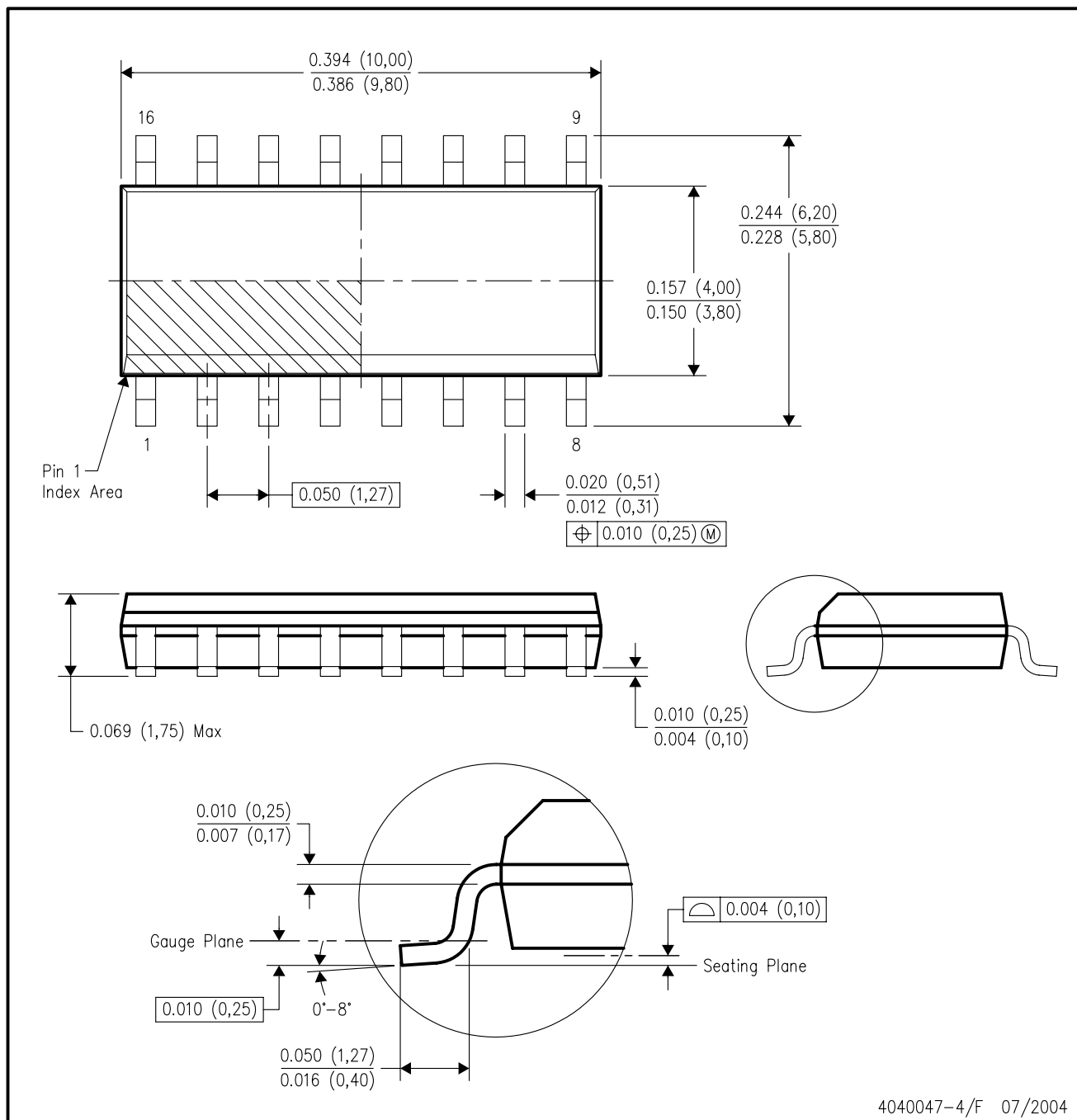


4040049/E 12/2002

- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
  - The 20 pin end lead shoulder width is a vendor option, either half or full width.

## D (R-PDSO-G16)

## PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- All linear dimensions are in inches (millimeters).
  - This drawing is subject to change without notice.
  - Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
  - Falls within JEDEC MS-012 variation AC.

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DSP	<a href="http://dsp.ti.com">dsp.ti.com</a>	Broadband	<a href="http://www.ti.com/broadband">www.ti.com/broadband</a>
Interface	<a href="http://interface.ti.com">interface.ti.com</a>	Digital Control	<a href="http://www.ti.com/digitalcontrol">www.ti.com/digitalcontrol</a>
Logic	<a href="http://logic.ti.com">logic.ti.com</a>	Military	<a href="http://www.ti.com/military">www.ti.com/military</a>
Power Mgmt	<a href="http://power.ti.com">power.ti.com</a>	Optical Networking	<a href="http://www.ti.com/opticalnetwork">www.ti.com/opticalnetwork</a>
Microcontrollers	<a href="http://microcontroller.ti.com">microcontroller.ti.com</a>	Security	<a href="http://www.ti.com/security">www.ti.com/security</a>
		Telephony	<a href="http://www.ti.com/telephony">www.ti.com/telephony</a>
		Video & Imaging	<a href="http://www.ti.com/video">www.ti.com/video</a>
		Wireless	<a href="http://www.ti.com/wireless">www.ti.com/wireless</a>

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